

Product Change Notice

(Notification - P1310061)

October 2, 2013

To: *Our Valued Customer (Name)*

Overview: The purpose of this notification is to communicate a product change of select Renesas Electronics America, Inc. (REA) devices. These devices are changing wafer fabrication sites. There is no part number change. Please see the "PCN Note" section for additional details.

Affected Products: A review of our shipment records to your company indicate the attached list of products is affected by this notification.

Booking Part Number	PCN Note
PN1	
PN2	
PN3	
PN4	

Part numbers given in this list are for active part numbers in REA database at the time of this notification.

Key Dates:

Final last time buy (LTB) orders for the affected part numbers from the current wafer fabrication site placed to REA or to a franchised REA distributor.	Nov. 22th, 2013
Planned date for last time shipment (LTS) from REA.	May 30th, 2014

Response: Please place last time buy (LTB) orders in a timely manner prior to the key dates listed to avoid product availability issues. If you anticipate volumes beyond your regular rate, please contact your REA sales representative with a forecast of your requirements. Shipments between the LTB and LTS dates are Non-Cancelable and Non-Returnable (NCNR).

You are encouraged to sample material from the new wafer fabrication site and begin qualification as soon as possible. Please contact you REA sales representative for sampling information.

Please contact your REA sales representative for any questions or comments.

Thank you for your attention.

Sincerely,

Renesas Electronics America, Inc.

Booking Part Number

Notes for PCN

RJK0451DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0451DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0452DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0452DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0453DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0453DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0454DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0454DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0601DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0602DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0603DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0653DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0653DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0654DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0654DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0657DPA-00#J5A	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0658DPA-00#J5A	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0658DPA-WS#J5A	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0659DPA-00#J5A	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0660DPA-00#J5A	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0660DPA-WS#J5A	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0701DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0701DPP-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0702DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0702DPP-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0703DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0703DPP-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0851DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0851DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0852DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
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RJK0854DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0854DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0856DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK0856DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1001DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1001DPP-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1002DPN-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1002DPP-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1003DPP-E0#T2	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1028DNS-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1051DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1051DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1052DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1052DPB-WS#J5	Wafer Fabrication Site Change from Kofu to Saijyo
RJK1053DPB-00#J5	Wafer Fabrication Site Change from Kofu to Saijyo

RJK1053DPB-WS#J5
RJK1055DPB-00#J5
RJK1055DPB-WS#J5
R1EV24004ASAS0I#K0
R2A30444BZ#W0

Wafer Fabrication Site Change from Kofu to Saijyo
Wafer Fabrication Site Change from Kofu to Saijyo
Wafer Fabrication Site Change from Kofu to Saijyo
Wafer Fabrication Site Change from Kofu to Naka
Wafer Fabrication Site Change from Kofu to GFT